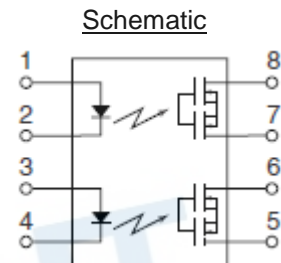
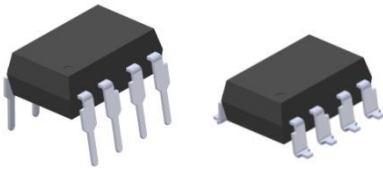


GENERAL PURPOSE SOLID STATE RELAY 8PIN DIP 2-CHANNEL TYPE FORM A SSR Series



Pin Configuration

- 1, 3 LED Anode
- 2, 4 LED Cathode
- 8, 7, 6, 5 MOSFET

Features

- Compact 8-pin DIP size
- Applicable for 2 Form A use as well as two independent 1Form A use
- Controls low-level analog signals
- High sensitivity and high speed response
- Low-level off state leakage current of max. 1uA
- Wide operating temperature range of -40°C to 85°C
- High isolation voltage between input and output (Viso = 5000 Vrms)
- UL 1577 + cUL approved (No. E214129)
- VDE approved (No. 40028391)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Description

The EL840A and EL860A are solid state relays containing an AlGaAs infrared LEDs on the light emitting side (input side) optically coupled to a high voltage output detector circuit. The detector consists of a photovoltaic diode array and MOSFETs on the output side. The dual channel configuration is equivalent to 1 form A EMR. They are packaged in 8 pin DIP and available in surface mount SMD option.

Applications

- High-speed inspection machines
- Telephones equipment
- Computer

Absolute Maximum Ratings (T_A=25 °C, unless otherwise specified)

Parameter	Symbol	Rating		Unit	
		EL840A	EL860A		
Input	Forward Current	I _F	50	mA	
	Reverse Voltage	V _R	5	V	
	Peak Forward Current* ¹	I _{FP}	1	A	
	Power Dissipation	P _{in}	75	mW	
Output	Break Down Voltage* ²	V _L	400	600	V
	Continuous Load Current* ²	I _L	120	50	mA
	Pulse Load Current* ³	I _{LPeak}	0.3	0.15	A
	Power Dissipation	P _{out}	800		mW
Total Power Dissipation	P _T	850		mW	
Isolation Voltage* ⁴	V _{iso}	5000		V _{rms}	
Storage Temperature	T _{STG}	-40 to 125		°C	
Operating Temperature	T _{OPR}	-40 to 85		°C	
Soldering Temperature* ⁵	T _{SOL}	260		°C	

Notes:

*1. f =100Hz, Duty Cycle = 0.1%

*2. Indicate the peak AC and DC values

*3.A connection: 100ms (1 shot), V_L = DC or Peak AC

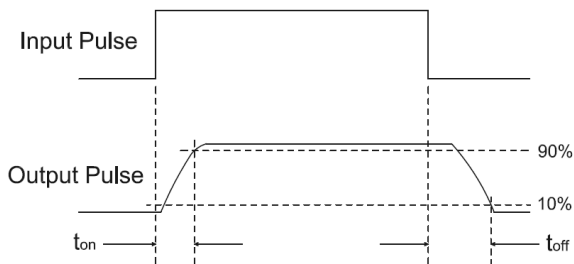
*4.AC for 1 minute, R.H. = 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

*5.For 10 seconds

Electro-Optical Characteristics ($T_A=25\text{ }^\circ\text{C}$)

	Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V_F	$I_F = 10\text{mA}$	-	1.18	1.5	V
	Reverse Current	I_R	$V_R = 5\text{V}$	-	-	1	μA
Output	Off State leakage Current	I_{leak}	$I_F = 0\text{mA}, V_L = \text{Max.}$	-	-	1	μA
	On Resistance	$R_{d(ON)}$	$I_F = 10\text{mA}, I_L = \text{Max.}$ $t = 1\text{s}$	-	20	30	Ω
				-	40	70	
	Output Capacitance	C_{out}	$V_L = 0\text{V}, f = 1\text{MHz}$	-	45	-	pF
-				30	-		
Transfer Characteristics	LED turn on Current	$I_{F(on)}$	$I_L = \text{Max.}$	-	3.0	5	mA
				-	3.0	5	
	LED turn off current	$I_{F(off)}$	$I_L = \text{Max.}$	0.4	3.0	-	mA
				0.4	3.0	-	
	Turn On Time	T_{on}	$I_F = 10\text{mA}, I_L = \text{Max.}$ $R_L = 200\Omega,$	-	0.4	3	ms
				-	1.4	3	
	Turn Off Time	T_{off}	$I_F = 10\text{mA}, I_L = \text{Max.}$ $R_L = 200\Omega,$	-	0.05	0.5	ms
				-	0.05	0.5	
	Isolation Resistance	R_{I-O}	$V_{I-O} = 500\text{V DC}$	5×10^{10}	-	-	Ω
	Isolation Capacitance	C_{I-O}	$V = 0\text{V}, f = 1\text{MHz}$	1.5	-	-	pF

Turn on/Turn off Time



Typical Electro-Optical Characteristics Curves

Figure 1. Load current vs Ambient temperature

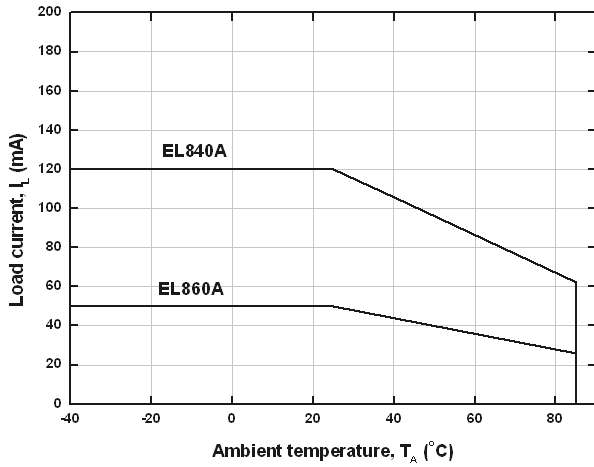


Figure 2. On Resistance vs Ambient Temperature

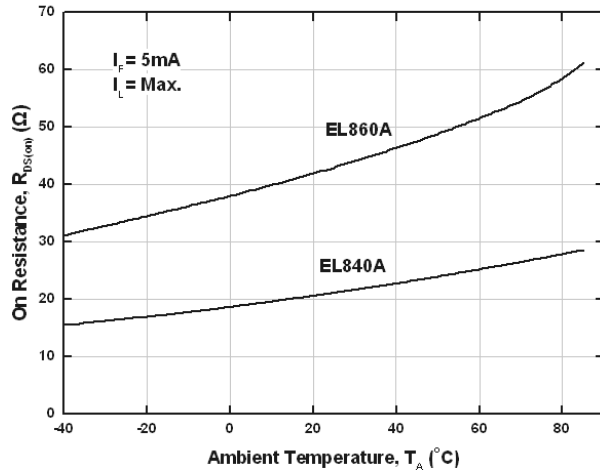


Figure 3. Switching Time vs Ambient Temperature

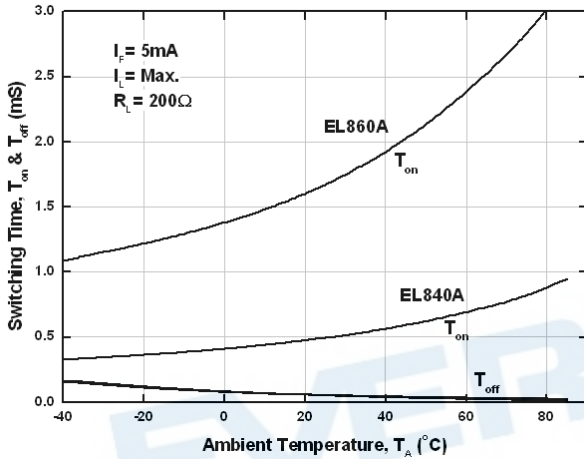


Figure 4. Turn On Time vs LED Forward Current

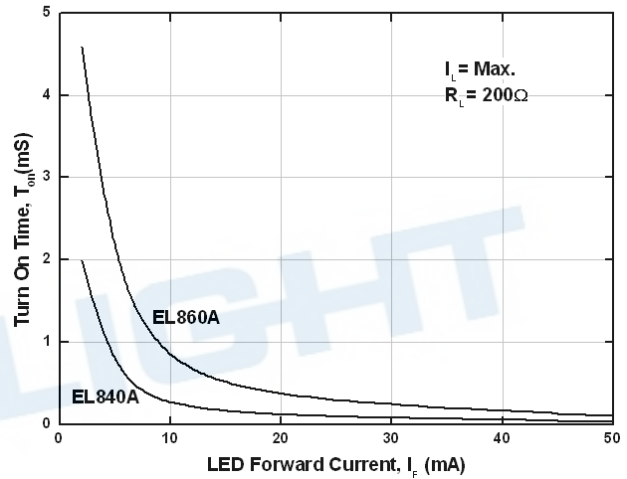


Figure 5. Turn Off Time vs LED Forward Current

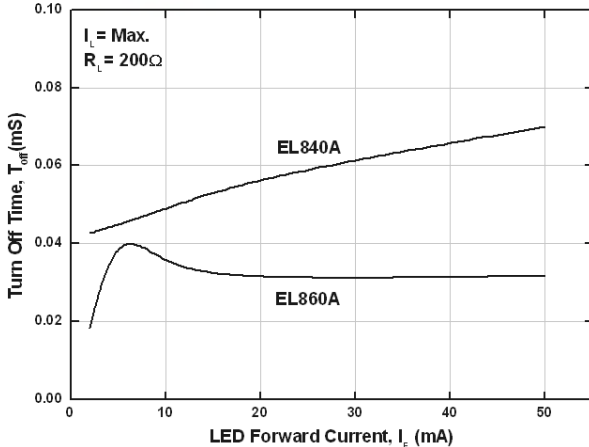


Figure 6. LED Operate on Current vs Ambient Temperature

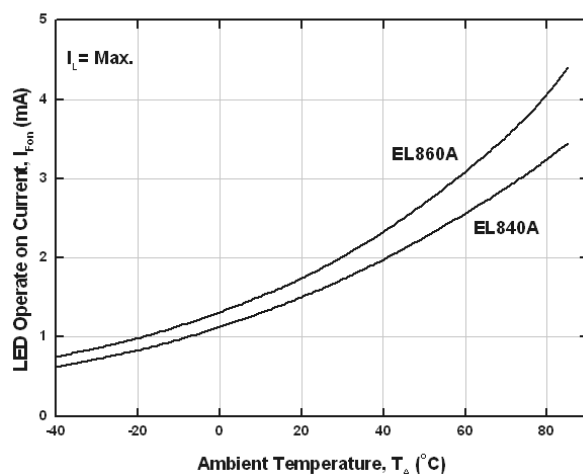


Figure 7. LED Turn off Current vs Ambient Temperature

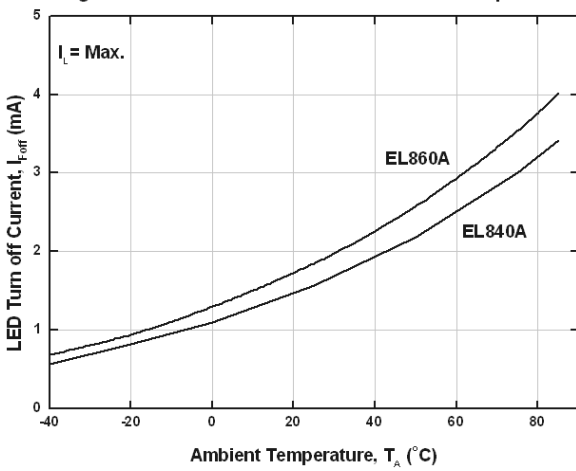


Figure 8. LED Dropout Voltage vs Ambient Temperature

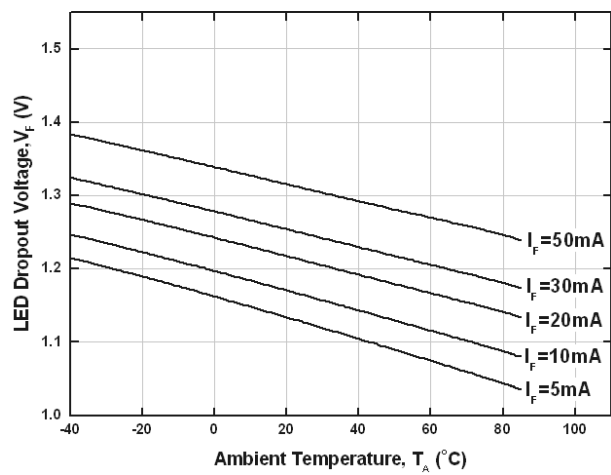


Figure 9. Load Voltage vs Load Current

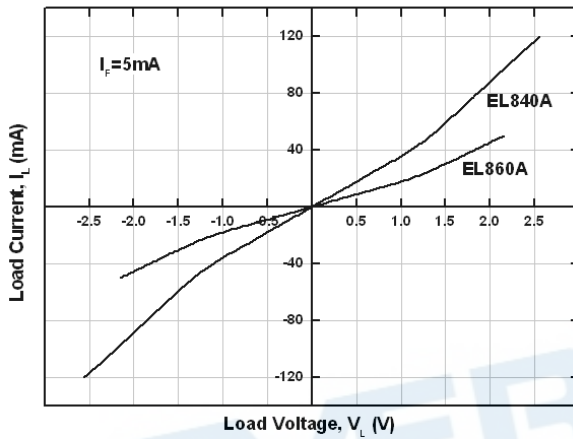


Figure 10. Off State Leakage Current vs Load Voltage

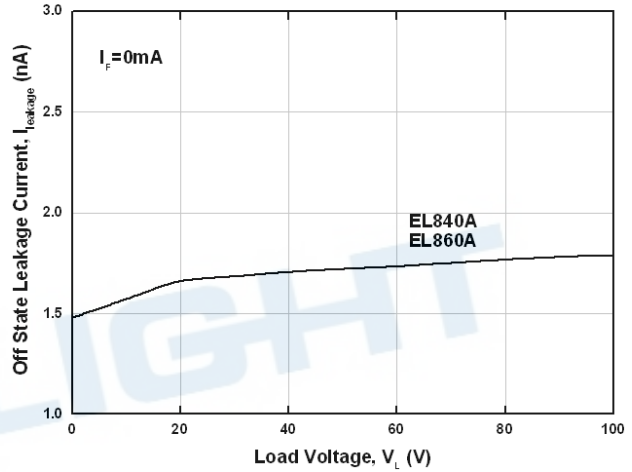
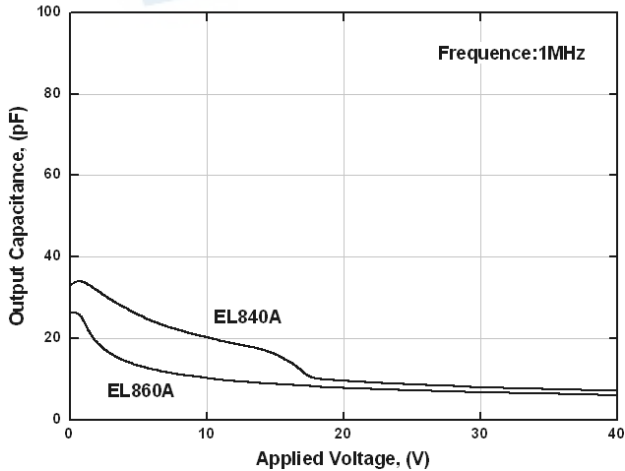


Figure 11. Applied Voltage VS Output Capacitance



Order Information

Part Number

EL8XXA(Y)(Z)-V

Note:

XX = Part No. (40 or 60)

Y = Lead form option (S1, or none)

Z = Tape and reel option (TA, TB, TU, TD or none).

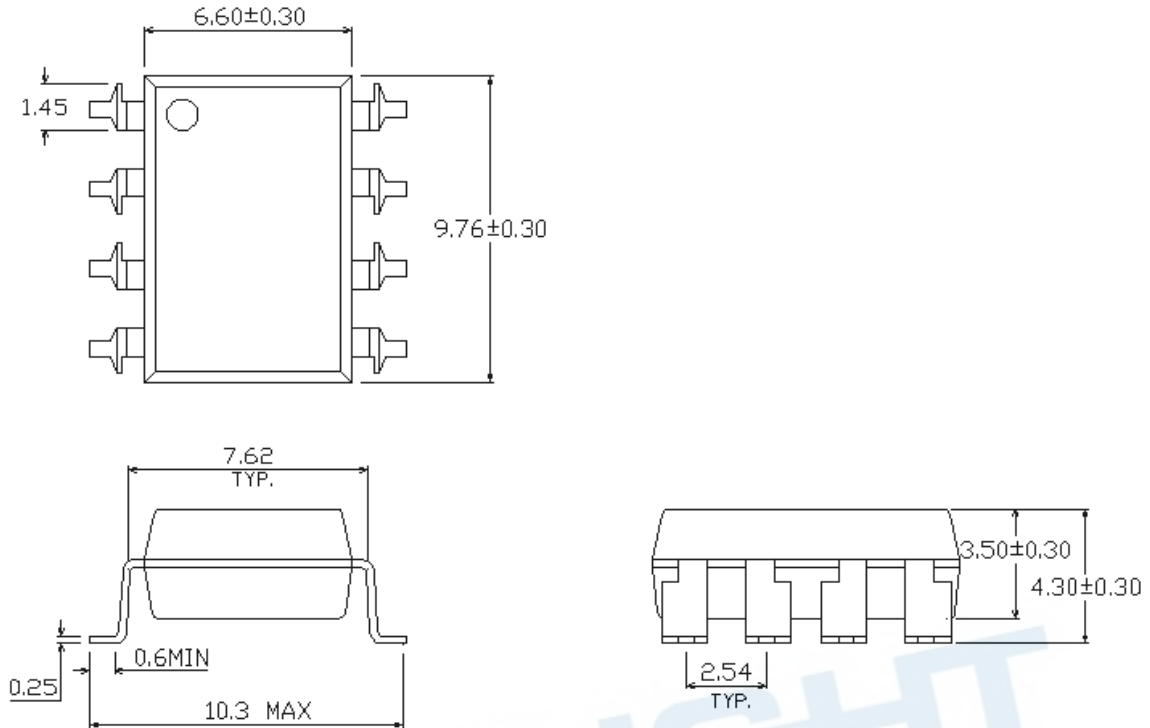
V = VDE safety approved option

Option	Description	Packing quantity
None	Standard DIP-8	45 units per tube
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

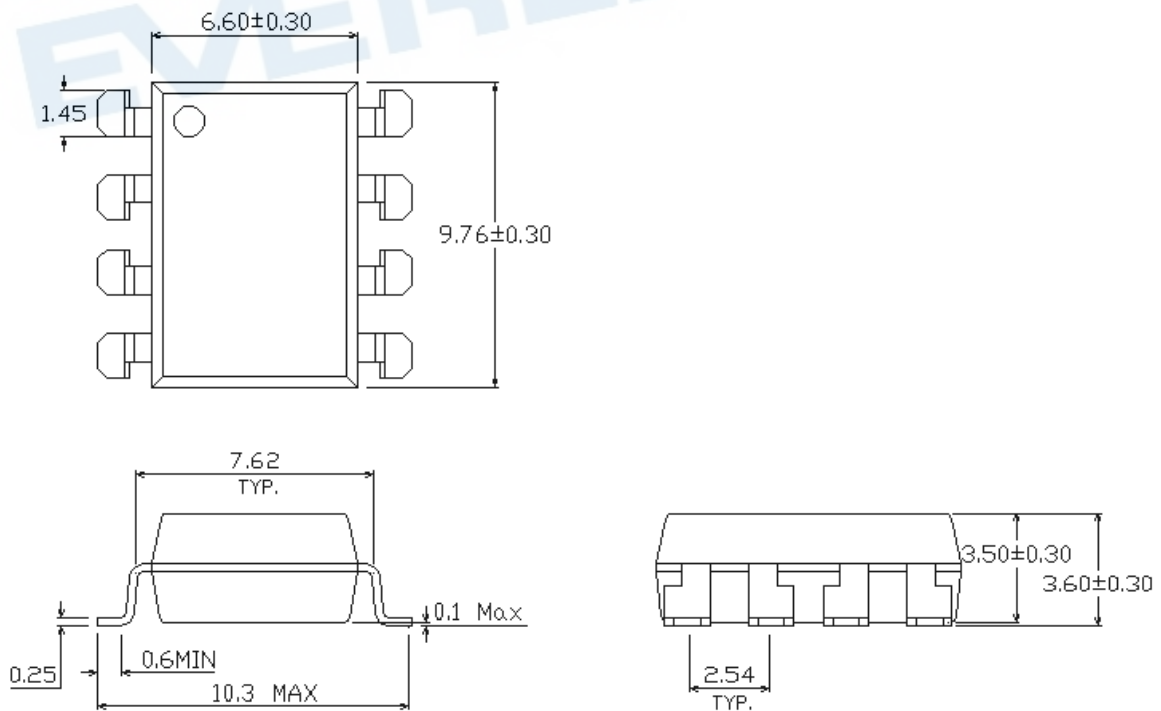
EVERLIGHT

Package Dimension
(Dimensions in mm)

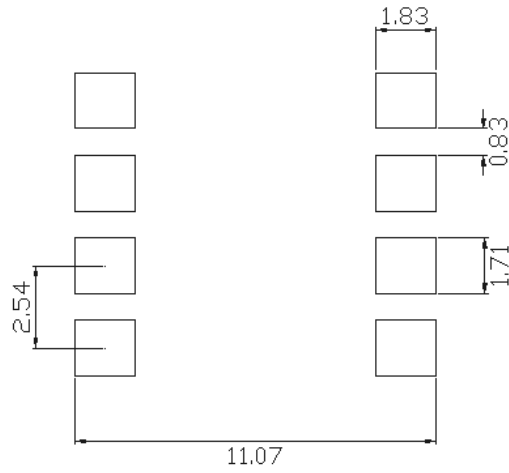
Standard DIP Type



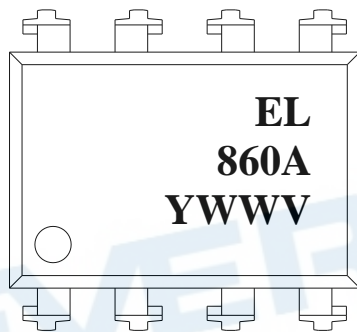
Option S1 Type



Recommended Pad Layout for Surface Mount Leadform



Device Marking

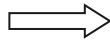
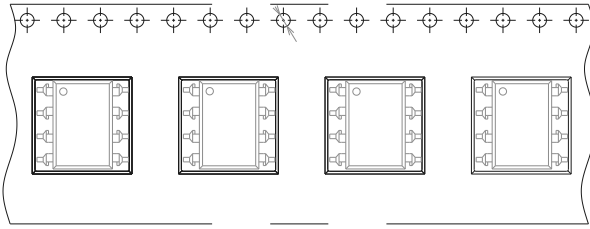


Notes

- EL denotes Everlight
- 860A denotes Part Number
- Y denotes 1 digit Year code
- WW denotes 2 digit Week code
- V denotes VDE option

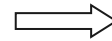
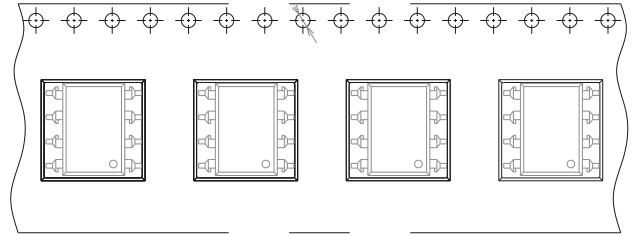
Tape & Reel Packing Specifications

Option TA



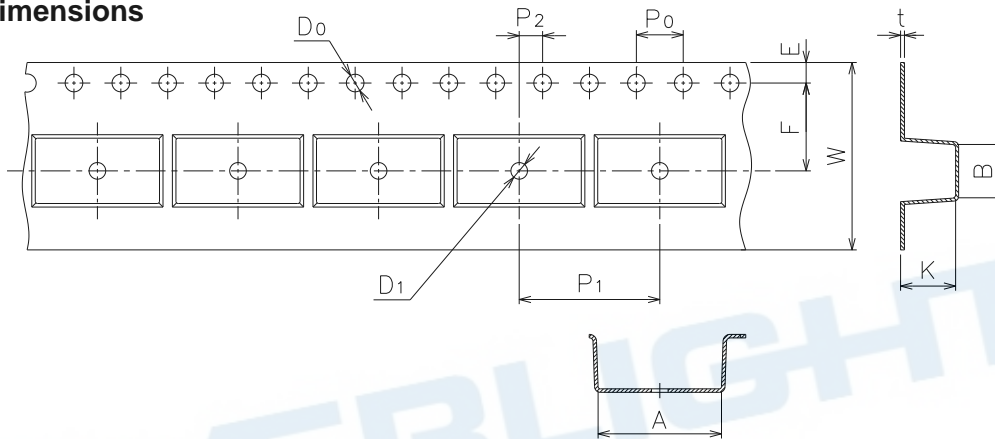
Direction of feed from reel

Option TB



Direction of feed from reel

Tape Dimensions

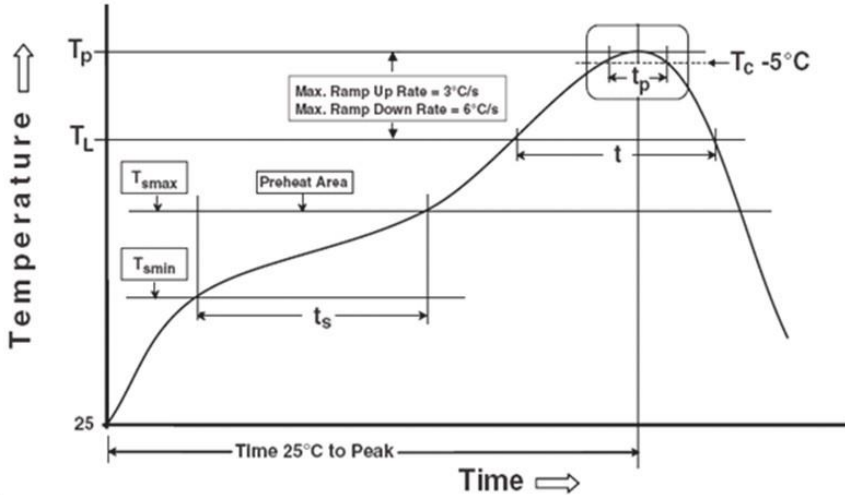


Dimension No.	A	B	Do	D1	E	F
Dimension(mm)	10.4±0.1	10.0±0.1	1.5+0.1/-0	1.5±0.25/-0	1.75±0.1	7.5±0.1
Dimension No.	Po	P1	P2	t	W	K
Dimension(mm)	4.0±0.1	12.0±0.1	2.0±0.05	0.4±0.05	16.0±0.3/	4.5±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: $T_P - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

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